

# 80V N-Channel Enhancement Mode MOSFET

Voltage

80 V

Current

78 A

#### **Features**

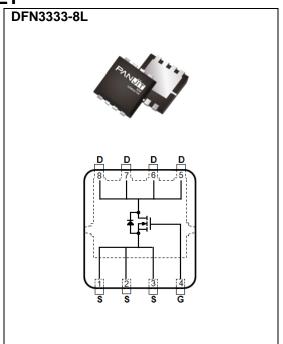
- RDS(ON), VGS@10V, ID@10A<7m $\Omega$
- RDS(ON), VGS@4.5V, ID@6A<11m $\Omega$
- Excellent FOM
- Logic Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: DFN3333-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.03 grams



# **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	80	- V	
Gate-Source Voltage		$V_{GS}$	±20		
Continuous Drain Current(Note 3)	T <sub>C</sub> =25°C		78		
	T <sub>C</sub> =100°C	l <sub>D</sub>	55	Α	
Pulsed Drain Current(Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	305		
Power Dissipation	T <sub>C</sub> =25°C	D-	86	W	
	T <sub>C</sub> =100°C	Po	43		
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C		13.4	А	
	T <sub>A</sub> =70°C	I <sub>D</sub>	11.2		
Power Dissipation	T <sub>A</sub> =25°C	PD	2.5	W	
	T <sub>A</sub> =70°C		1.8		
Single Pulse Avalanche Current(Note 5)		I <sub>AS</sub>	17.5	Α	
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	128	mJ	
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	R <sub>θJC</sub>	1.75	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60		



### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

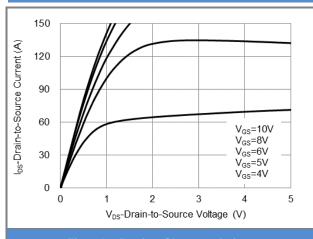
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	80	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.3	1.8	2.5		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>G</sub> S=10V, I <sub>D</sub> =10A	ı	5.6	7	0	
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	ı	8.2	11	mΩ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	ı	-	1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA	
Dynamic <sup>(Note 6)</sup>						_	
Total Gate Charge	$Q_g$	V <sub>DS</sub> =40V, I <sub>D</sub> =10A,	-	50	65	nC	
Gate-Source Charge	Qgs		-	6	-		
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V <sup>(Note 2)</sup>	ı	14	-		
Input Capacitance	Ciss	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V,	ı	2065	2700	pF	
Output Capacitance	Coss		ı	496	750		
Reverse Transfer Capacitance	Crss	f=1MHz	ı	23	45		
Gate resistance	Rg	f=1MHz	ı	1.3	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>	$V_{DS}$ =40V, $I_{D}$ =10A, $V_{GS}$ =10V, $R_{G}$ =3 $\Omega$ (Note 2)	ı	11	-		
Turn-On Rise Time	tr		ı	12.4	-		
Turn-Off Delay Time	td <sub>(off)</sub>		ı	42	-	ns	
Turn-Off Fall Time	tf	(14016-2)	-	15	-		
Drain-Source Diode							
Diode Forward Current	Is	T <sub>C</sub> =25°C	-	-	78	A	
Pulsed Diode Forward Current	I <sub>SM</sub>	(Package Limit)	ı	-	305		
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =20A, V <sub>GS</sub> =0V	-	0.85	1.3	V	
Reverse Recovery Time	Trr	V <sub>DD</sub> =40V,V <sub>GS</sub> =0V,	-	42	-	ns	
Reverse Recovery Charge	Qrr	I <sub>S</sub> =10A,dI <sub>S</sub> /dt=100A/us	-	42	-	nC	

#### NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an  $R_{\theta JC}=1.75^{\circ}C/W$ .
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5.  $E_{AS}$  is calculated based on the condition of L=1mH,  $I_{AS}$ =16A,  $V_{DD}$ =30V,  $V_{GS}$ =10V. 100% test at L=0.5mH,  $I_{AS}$ =17.5A in production.
- 6. Guaranteed by design, not subject to production testing.



#### **TYPICAL CHARACTERISTIC CURVES**



**Fig.1 On-Region Characteristics** 

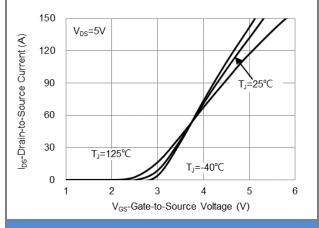


Fig.2 Transfer Characteristics

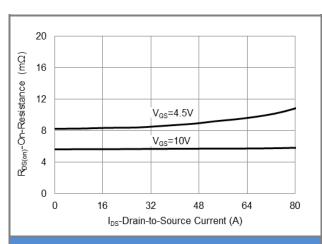


Fig.3 On-Resistance vs. Drain Current

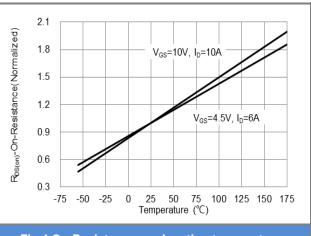
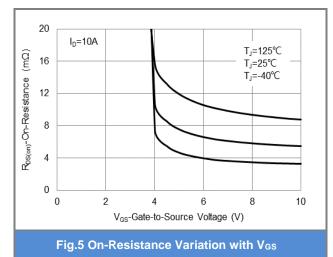
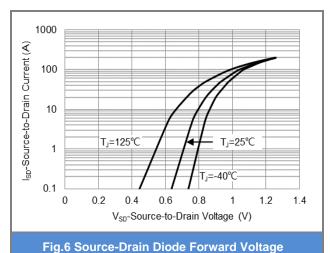


Fig.4 On-Resistance vs. Junction temperature







#### **TYPICAL CHARACTERISTIC CURVES**

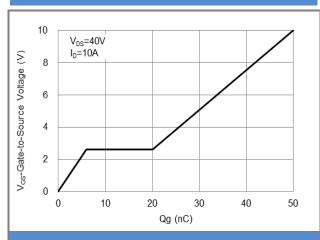


Fig.7 Gate-Charge Characteristics

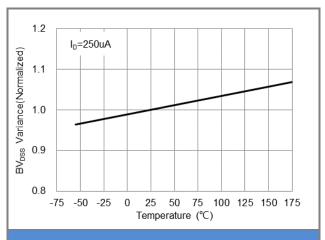


Fig.8 Breakdown Voltage Variation vs. Temperature

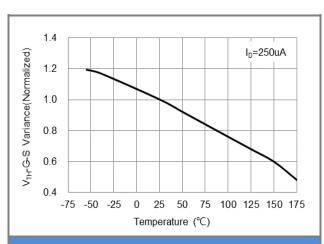


Fig.9 Threshold Voltage Variation with Temperature

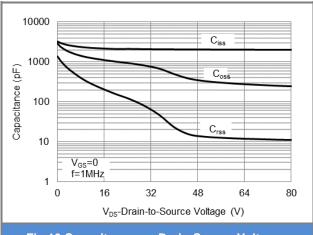
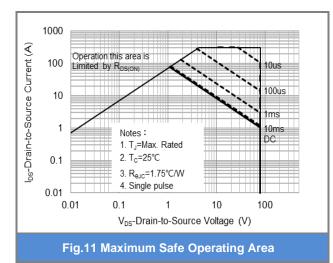


Fig.10 Capacitance vs. Drain-Source Voltage



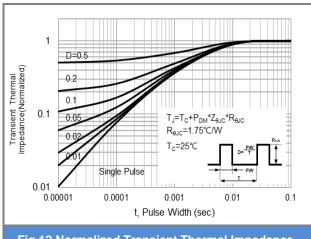


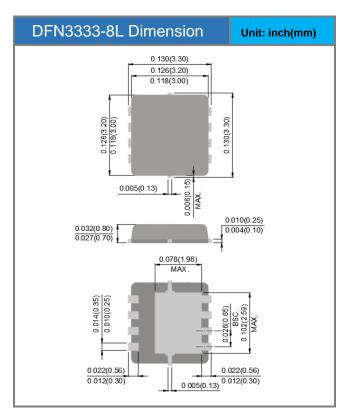
Fig.12 Normalized Transient Thermal Impedance

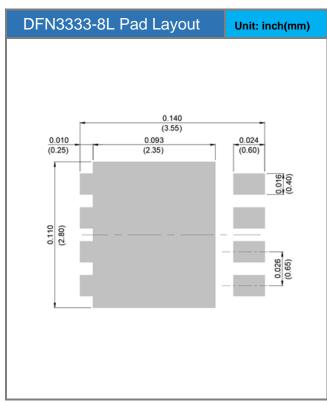


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJQ45808AP-AU	DFN3333-8L	5K pcs / 13" reel	45808A	

### **Packaging Information & Mounting Pad Layout**







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